# DATA SHEET

**SAA7197**

# Clock Generator Circuit for desktop video systems (CGC)

Product specification

File under Integrated Circuits, IC22

August 1996

**Philips**
**Semiconductors**

**PHILIPS**

# Clock Generator Circuit for desktop video systems (CGC)     SAA7197

## FEATURES

- Suitable for Desktop Video systems

- Two different sync sources selectable

- PLL frequency multiplier to generate 4 times of input frequency

- Dividers to generate clocks LLCA, LLCB, LLC2A and LLC2B (2nd and 4th multiples of input frequency)

- PLL mode or VCO mode selectable

- Reset control and power fail detection
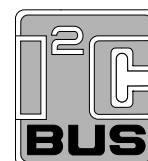
## GENERAL DESCRIPTION

The SAA7197 generates all clock signals required for a digital TV system suitable for the SAA719x family. The circuit operates in either the phase-locked loop mode (PLL) or voltage controlled oscillator mode (VCO).

## QUICK REFERENCE DATA

| SYMBOL | PARAMETER | MIN. | TYP. | MAX. | UNIT |
|--------|-----------|------|------|------|------|
| $V_{DDA}$ | analog supply voltage (pin 5) | 4.5 | 5.0 | 5.5 | V |
| $V_{DDD}$ | digital supply voltage (pins 8, 17) | 4.5 | 5.0 | 5.5 | V |
| $I_{DDA}$ | analog supply current | 3 | – | 9 | mA |
| $I_{DDD}$ | digital supply current | 10 | – | 60 | mA |
| $V_{LFCO}$ | LFCO input voltage (peak-to-peak value) | 1 | – | $V_{DDA}$ | V |
| $f_i$ | input frequency range | 5.5 | – | 8.0 | MHz |
| $V_I$ | input voltage LOW | 0 | – | 0.8 | V |
|  | input voltage HIGH | 2.0 | – | $V_{DDD}$ | V |
| $V_O$ | output voltage LOW | 0 | – | 0.6 | V |
|  | output voltage HIGH | 2.6 | – | $V_{DDD}$ | V |
| $T_{amb}$ | operating ambient temperature range | 0 | – | 70 | °C |

## ORDERING INFORMATION

| EXTENDED TYPE NUMBER | PACKAGE | | | |
|----------------------|---------|---|---|---|
|  | PINS | PIN POSITION | MATERIAL | CODE |
| SAA7197P | 20 | DIP | plastic | SOT146-1 |
| SAA7197T | 20 | SO | plastic | SOT163-1 |

## Clock Generator Circuit for desktop video systems (CGC)    SAA7197
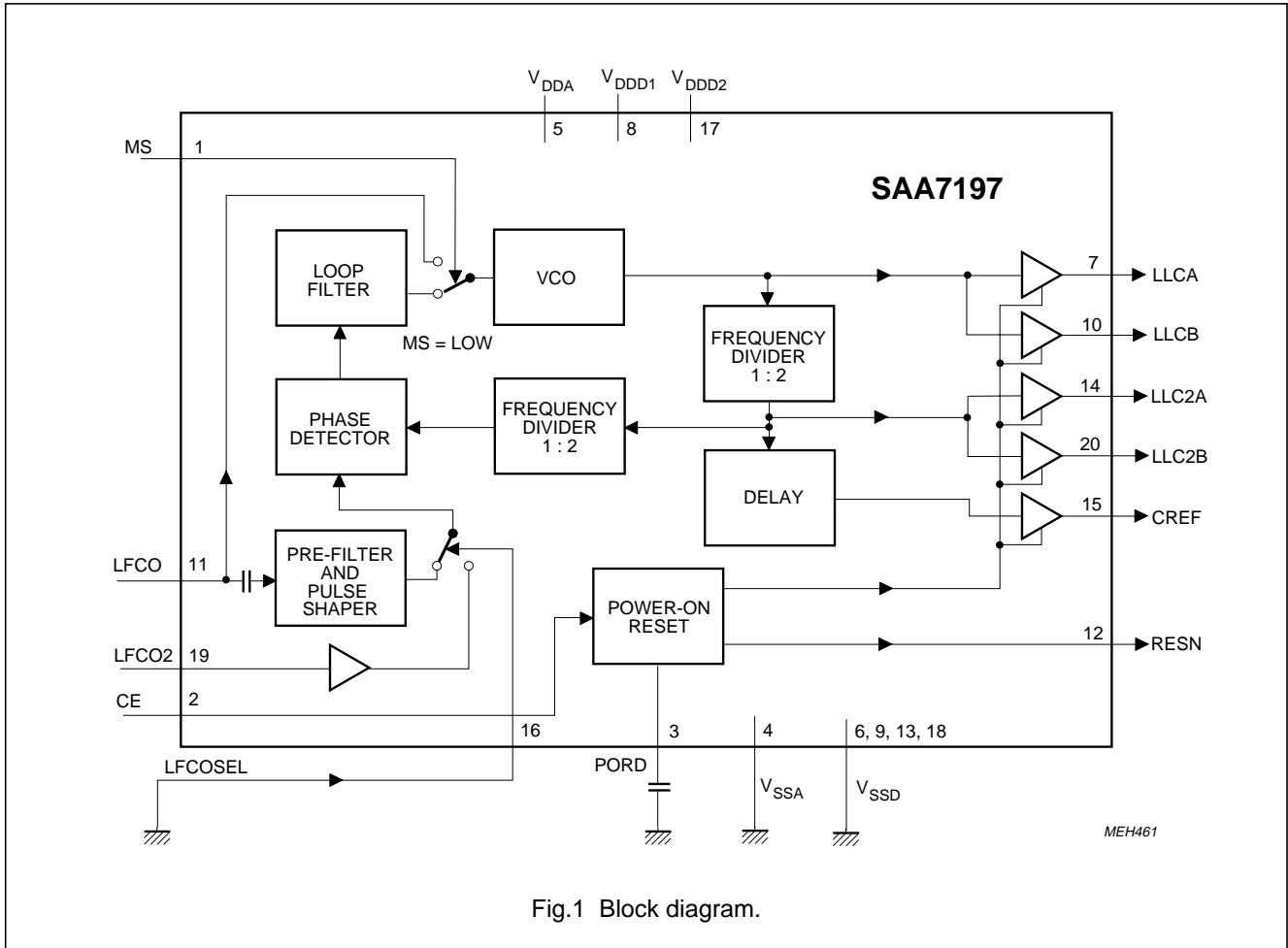
**BLOCK DIAGRAM**



Fig.1  Block diagram.

**FUNCTION DESCRIPTION**

The SAA7197 generates all clock signals required for a digital TV system suitable for the SAA719x family consisting of an 8-bit analog-to-digital converter (ADC8), digital video multistandard decoder, square pixel (DMSD-SQP), digital video colour space converter (DCSC) and optional extensions. The SAA7197 completes a system for Desktop Video applications in conjunction with memory controllers.

The input signal LFCO is a digital-to-analog converted signal provided by the DMDS-SQPs horizontal PLL. It is the multiple of the line frequency:

7.38 MHz = $472 \times f_H$ in 50 Hz systems
6.14 MHz = $360 \times f_H$ in 60 Hz systems

LFCO2 (TTL-compatible signal from an external reference source) can be applied to pin 19 (LFCOSEL = HIGH).

The input signal LFCO or LFCO2 is multiplied by factors 2 or 4 in the PLL (including phase detector, loop filter, VCO and frequency divider) and output on LLCA (pin7), LLCB (pin 10), LLC2A (pin 14) and LLC2B (pin 20). The rectangular output signals have 50% duty factor. Outputs with equal frequency may be connected together externally. The clock outputs go HIGH during power-on reset (and chip enable) to ensure that no output clock signals are available the PLL has locked-on.

**Mode select MS**

The LFCO input signal is directly connected to the VCO at MS = HIGH. The circuit operates as an oscillator and frequency divider. This function is not tested.

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### Source select LFCOSEL

Line frequency control signal LFCO (pin 11) is selected by LFCOSEL = LOW. LFCOSEL = HIGH selects LFCO2 input signal (pin 19). This function is not tested.

### Chip enable CE

The buffer outputs are enabled and RESN set HIGH by CE = HIGH (Fig.4). CE = LOW sets the clock outputs HIGH and RESN output LOW.

### CREF output

2 $f_{LFCO}$ output to control the clock dividers of the DMSD-SQP chip family.

### Power-on reset

Power-on reset is activated at power-on, when the supply voltage decreases below 3.5 V (Fig.4) or when chip enable is done. The indicator output RESN is LOW for a time determined by capacitor on pin 3. The RESN signal can be applied to reset other circuits of this digital TV system. The LFCO or LFCO2 input signals have to be applied before RESN becomes HIGH.

### PINNING

| SYMBOL | PIN | DESCRIPTION |
|--------|-----|-------------|
| MS | 1 | mode select input (LOW = PLL mode)[1] |
| CE | 2 | chip enable /reset (HIGH = outputs enabled) |
| PORD | 3 | power-on reset delay, dependent on external capacitor |
| $V_{SSA}$ | 4 | analog ground (0 V) |
| $V_{DDA}$ | 5 | analog supply voltage (+5 V) |
| $V_{SSD1}$ | 6 | digital ground 1 (0 V) |
| LLCA | 7 | line-locked clock output signal (4 times $f_{LFCO}$) |
| $V_{DDD1}$ | 8 | digital supply voltage 1 (+5 V) |
| $V_{SSD2}$ | 9 | digital ground 2 (0 V) |
| LLCB | 10 | line-locked clock output signal (4 times $f_{LFCO}$) |
| LFCO | 11 | line-locked frequency control input signal 1 |
| RESN | 12 | reset output (active-LOW, Fig.4) |
| $V_{SSD3}$ | 13 | digital ground 3 (0 V) |
| LLC2A | 14 | line-locked clock output signal 2A (2 times $f_{LFCO}$) |
| CREF | 15 | clock reference output, qualifier signal (2 times $f_{LFCO}$) |
| LFCOSEL | 16 | LFCO source select (LOW = LFCO selected)[1] |
| $V_{DDD2}$ | 17 | digital supply voltage 2 (+5 V) |
| $V_{SSD4}$ | 18 | digital ground 4 (0 V) |
| LFCO2 | 19 | line-locked frequency control input signal 2[1] |
| LLC2B | 20 | line-locked clock output signal 2B (2 times $f_{LFCO}$) |

### PIN CONFIGURATION



Fig.2  Pin configuration.
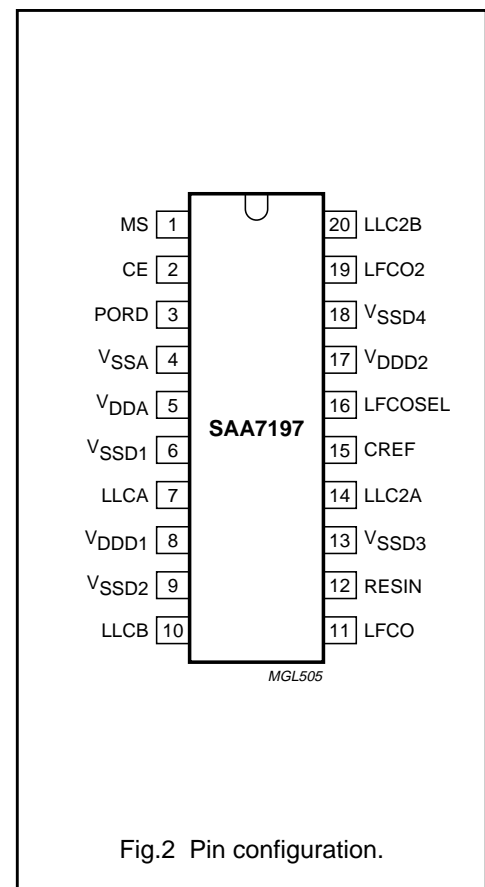
### Note

1. MS and LFCO2 functions are not tested. LFCO2 is a multiple of horizontal frequency.

## Clock Generator Circuit for desktop video systems (CGC)    SAA7197

### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134);
ground pins as well as supply pins together connected.

| SYMBOL | PARAMETER | MIN. | MAX. | UNIT |
|---|---|---|---|---|
| $V_{DDA}$ | analog supply voltage (pin 5) | −0.5 | 7.0 | V |
| $V_{DDD}$ | digital supply voltage (pins 8 and 17) | −0.5 | 7.0 | V |
| $V_{diff\ GND}$ | difference voltage $V_{DDA} - V_{DDD}$ | – | ±100 | mV |
| $V_O$ | output voltage ($I_{OM}$ = 20 mA) | −0.5 | $V_{DDD}$ | V |
| $P_{tot}$ | total power dissipation (DIL20) | 0 | 1.1 | W |
| $T_{stg}$ | storage temperature range | −65 | 150 | °C |
| $T_{amb}$ | operating ambient temperature range | 0 | 70 | °C |
| $V_{ESD}$ | electrostatic handling[1] for all pins | – | tbf | V |

**Note**

1. Inputs and outputs are protected against electrostatic discharge in normal handling. However, to be totally safe, it is recommended to take normal handling precautions appropriate to *"Handling MOS devices"*.

### CHARACTERISTICS

$V_{DDA}$ = $V_{DDD}$ = 4.5 to 5.5 V; $f_{LFCO}$ = 5.5 to 8.0 MHz and $T_{amb}$ = 0 to 70 °C unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|---|---|---|---|---|---|
| $V_{DDA}$ | analog supply voltage (pin 5) | | 4.5 | 5.0 | 5.5 | V |
| $V_{DDD}$ | digital supply voltage (pins 8 and 17) | | 4.5 | 5.0 | 5.5 | V |
| $I_{DDA}$ | analog supply current (pin 5) | | 3 | – | 9 | mA |
| $I_{DDD}$ | digital supply current ($I_8 + I_{17}$) | note 1 | 10 | – | 60 | mA |
| $V_{reset}$ | power-on reset threshold voltage | Fig.4 | – | 3.5 | - | V |
| **Input LFCO** (pin 11) | | | | | | |
| $V_{11}$ | DC input voltage | | 0 | – | $V_{DDA}$ | V |
| $V_i$ | input signal (peak-to-peak value) | | 1 | – | $V_{DDA}$ | V |
| $f_{LFCO}$ | input frequency range | | 5.5 | – | 8.0 | MHz |
| $C_{11}$ | input capacitance | | – | – | 10 | pF |
| **Inputs MS, CE, LFCOSEL and LFCO2** (pins 1, 2, 16 and 19); note 3 | | | | | | |
| $V_{IL}$ | input voltage LOW | | 0 | – | 0.8 | V |
| $V_{IH}$ | input voltage HIGH | | 2.0 | – | $V_{DDD}$ | V |
| $f_{LFCO2}$ | input frequency range for LFCO2 | | 5.5 | – | 8.0 | MHz |
| $I_{LI}$ | input leakage current | LFCOSEL | 50 | – | 150 | μA |
| | | others | – | – | 10 | μA |
| $C_I$ | input capacitance | | – | – | 5 | pF |
| **Output RESN** (pin 12) | | | | | | |
| $V_{OL}$ | output voltage LOW | $I_{OL}$ = 2 mA | 0 | – | 0.4 | V |
| $V_{OH}$ | output voltage HIGH | $I_{OH}$ = −0.5 mA | 2.4 | – | $V_{DDD}$ | V |
| $t_d$ | RESN delay time | $C_3$ = 0.1 μF; Fig.4 | 20 | – | 200 | ms |

## Clock Generator Circuit for desktop video systems (CGC)          SAA7197

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|---|---|---|---|---|---|
| **Output CREF** (pin 15) | | | | | | |
| $V_{OL}$ | output voltage LOW | $I_{OL}$ = 2 mA | 0 | – | 0.6 | V |
| $V_{OH}$ | output voltage HIGH | $I_{OH}$ = −0.5 mA | 2.4 | – | $V_{DDD}$ | V |
| $f_{CREF}$ | output frequency CREF | Fig.3 | – | 2 $f_{LFCO(2)}$ | | MHz |
| $C_L$ | output load capacitance | | 15 | – | 40 | pF |
| $t_{SU}$ | set-up time | Fig.3; note 1 | 12 | – | – | ns |
| $t_{HD}$ | hold time | Fig.3; note 1 | 4 | – | – | ns |
| **Output signals LLCA, LLCB, LLC2A and LLC2B** (pins 7, 10, 14, and 20); note 3 | | | | | | |
| $V_{OL}$ | output voltage LOW | $I_{OL}$ = 2 mA | 0 | – | 0.6 | V |
| $V_{OH}$ | output voltage HIGH | $I_{OH}$ = −0.5 mA | 2.6 | – | $V_{DDD}$ | V |
| $t_{comp}$ | composite rise time | Fig.3; notes 1 and 2 | – | – | 8 | ns |
| $f_{LL}$ | output frequency LLCA | Fig.3 | – | 4 $f_{LFCO(2)}$ | | MHz |
| | output frequency LLCB | | – | 4 $f_{LFCO(2)}$ | | MHz |
| | output frequency LLC2A | | – | 2 $f_{LFCO(2)}$ | | MHz |
| | output frequency LLC2B | | – | 2 $f_{LFCO(2)}$ | | MHz |
| $t_r$, $t_f$ | rise and fall times | Fig.3 | – | – | 5 | ns |
| $t_{LL}$ | duty factor LLCA, LLCB, LLC2A and LLC2B (mean values) | note 1; Fig.3; at 1.5 V level | 40 | 50 | 60 | % |

**Notes**

1. $f_{LFCO}$ = 7.0 MHz and output load 40 pF (Fig.3). $V_{SSA}$ and $V_{SSD}$ short connected together.

2. $t_{comp}$ is the rise time from LOW of all clocks to HIGH of all clocks (Fig.3) including rise time, skew and jitter components. Measurements taken between 0.6 V and 2.6 V. Skew between two LLx clocks will not deviate more than ±2 ns if output loads are matched within 20%.

3. MS and LFCO2 functions not tested.

Fig.3  Output timing.

Fig.4 Reset procedure.

Fig.5 Internal circuit.
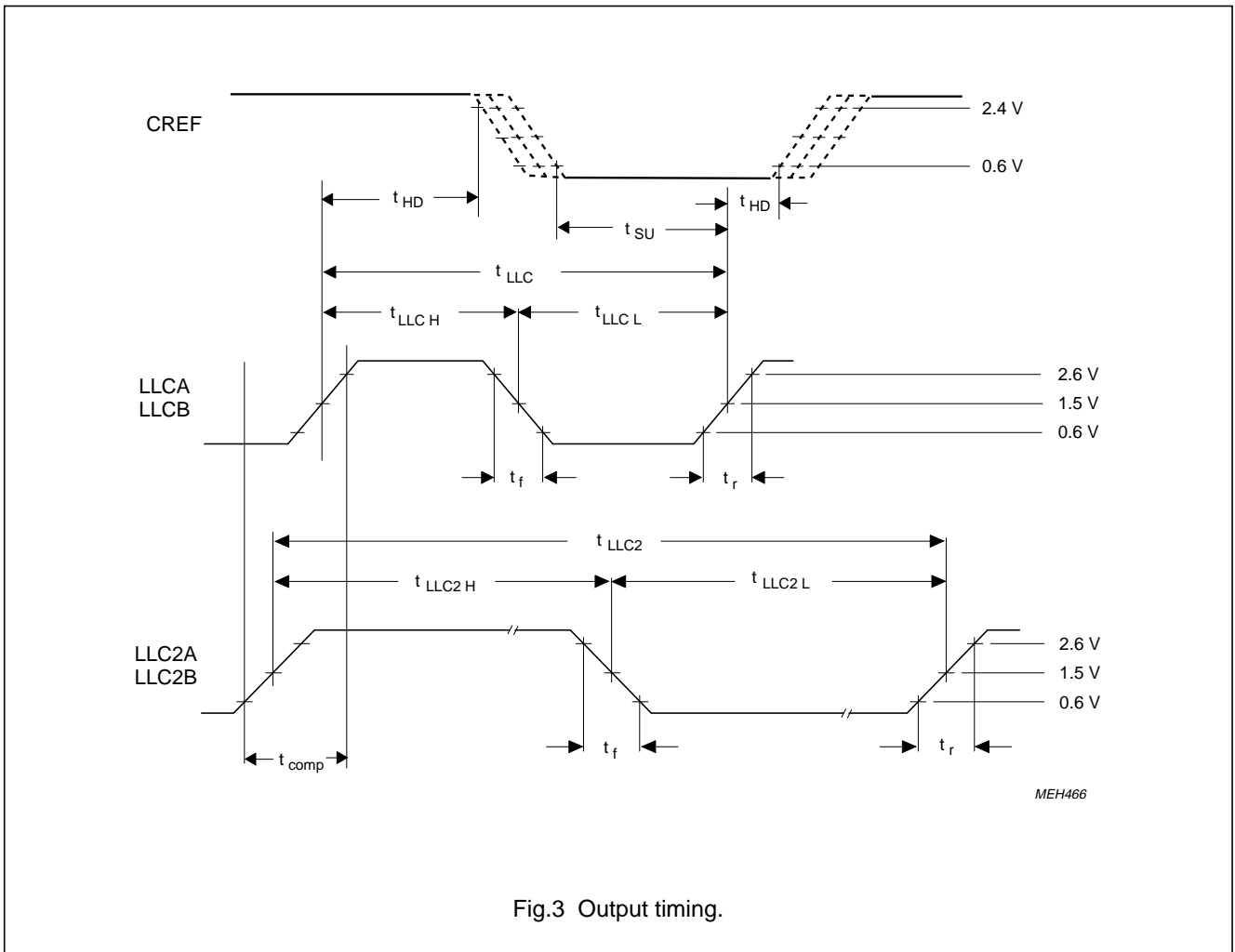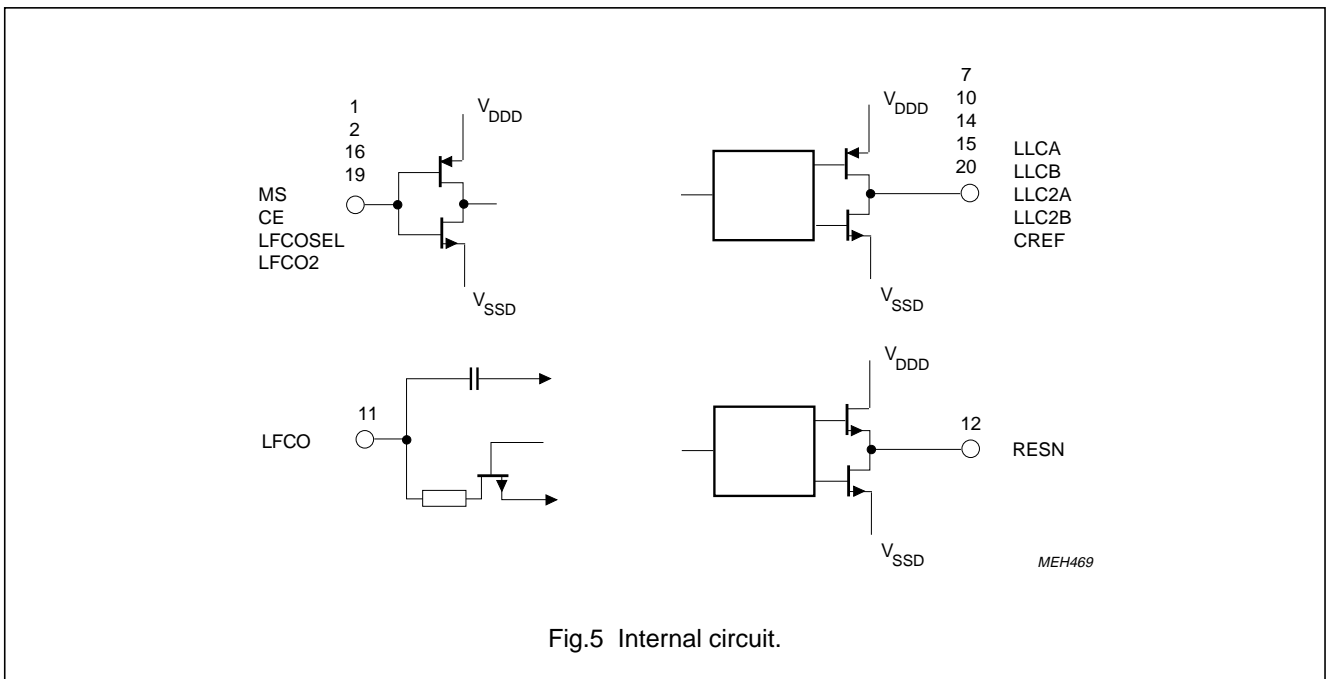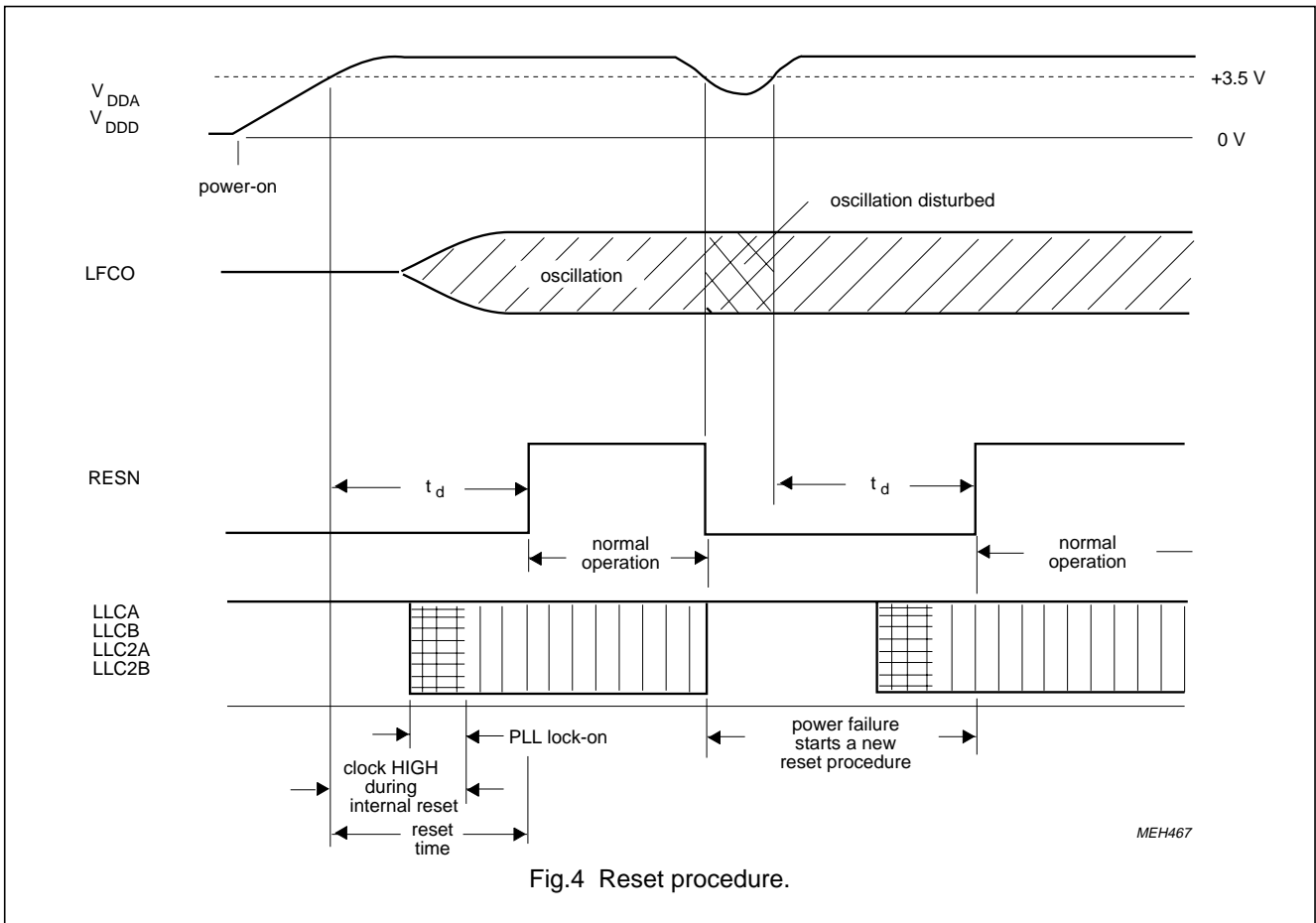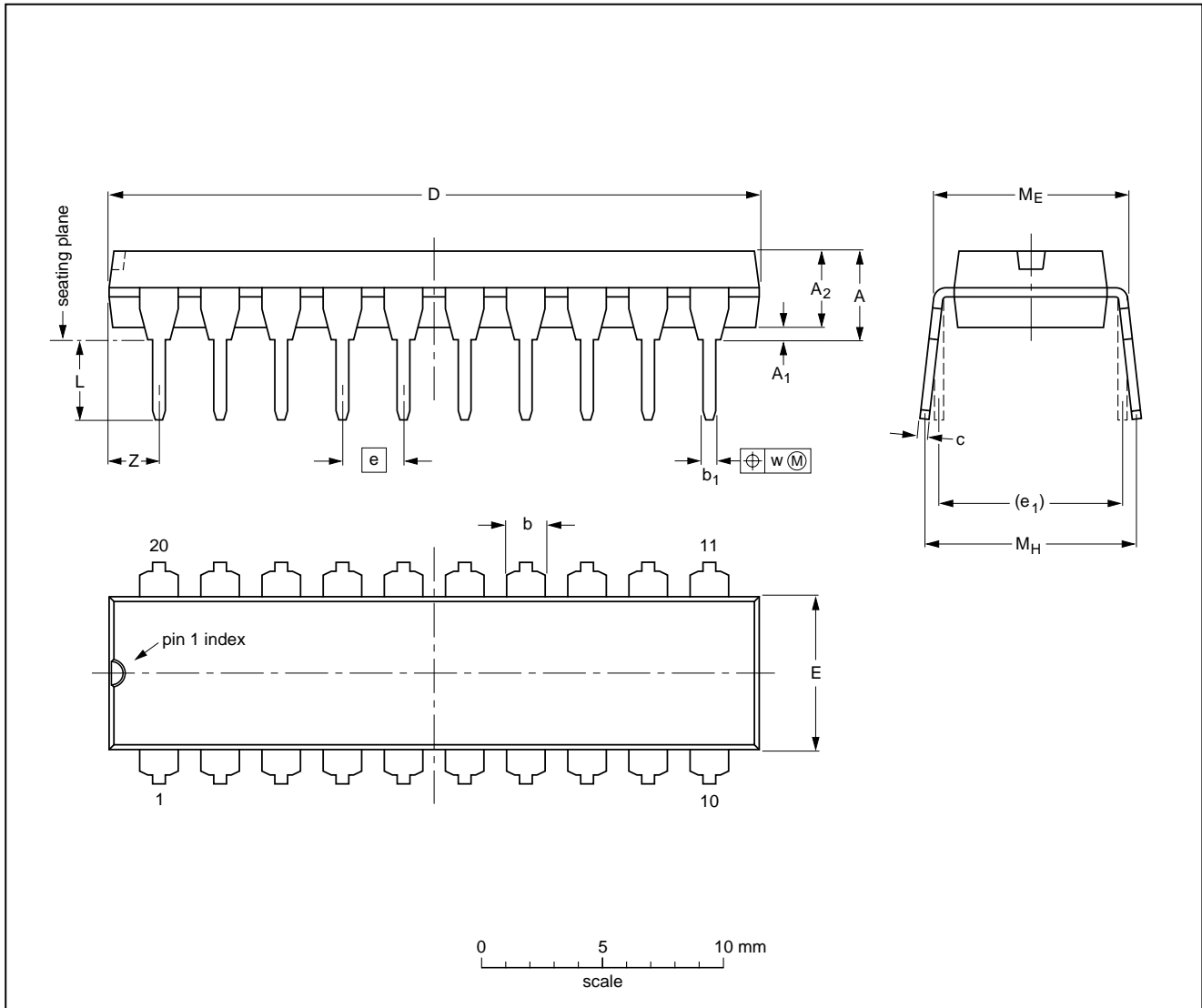
Clock Generator Circuit for desktop video systems (CGC) **SAA7197**

## PACKAGE OUTLINES

**DIP20: plastic dual in-line package; 20 leads (300 mil)** **SOT146-1**



**DIMENSIONS (inch dimensions are derived from the original mm dimensions)**

| UNIT | A max. | A₁ min. | A₂ max. | b | b₁ | c | D [1] | E [1] | e | e₁ | L | M_E | M_H | w | Z [1] max. |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| mm | 4.2 | 0.51 | 3.2 | 1.73 1.30 | 0.53 0.38 | 0.36 0.23 | 26.92 26.54 | 6.40 6.22 | 2.54 | 7.62 | 3.60 3.05 | 8.25 7.80 | 10.0 8.3 | 0.254 | 2.0 |
| inches | 0.17 | 0.020 | 0.13 | 0.068 0.051 | 0.021 0.015 | 0.014 0.009 | 1.060 1.045 | 0.25 0.24 | 0.10 | 0.30 | 0.14 0.12 | 0.32 0.31 | 0.39 0.33 | 0.01 | 0.078 |

**Note**

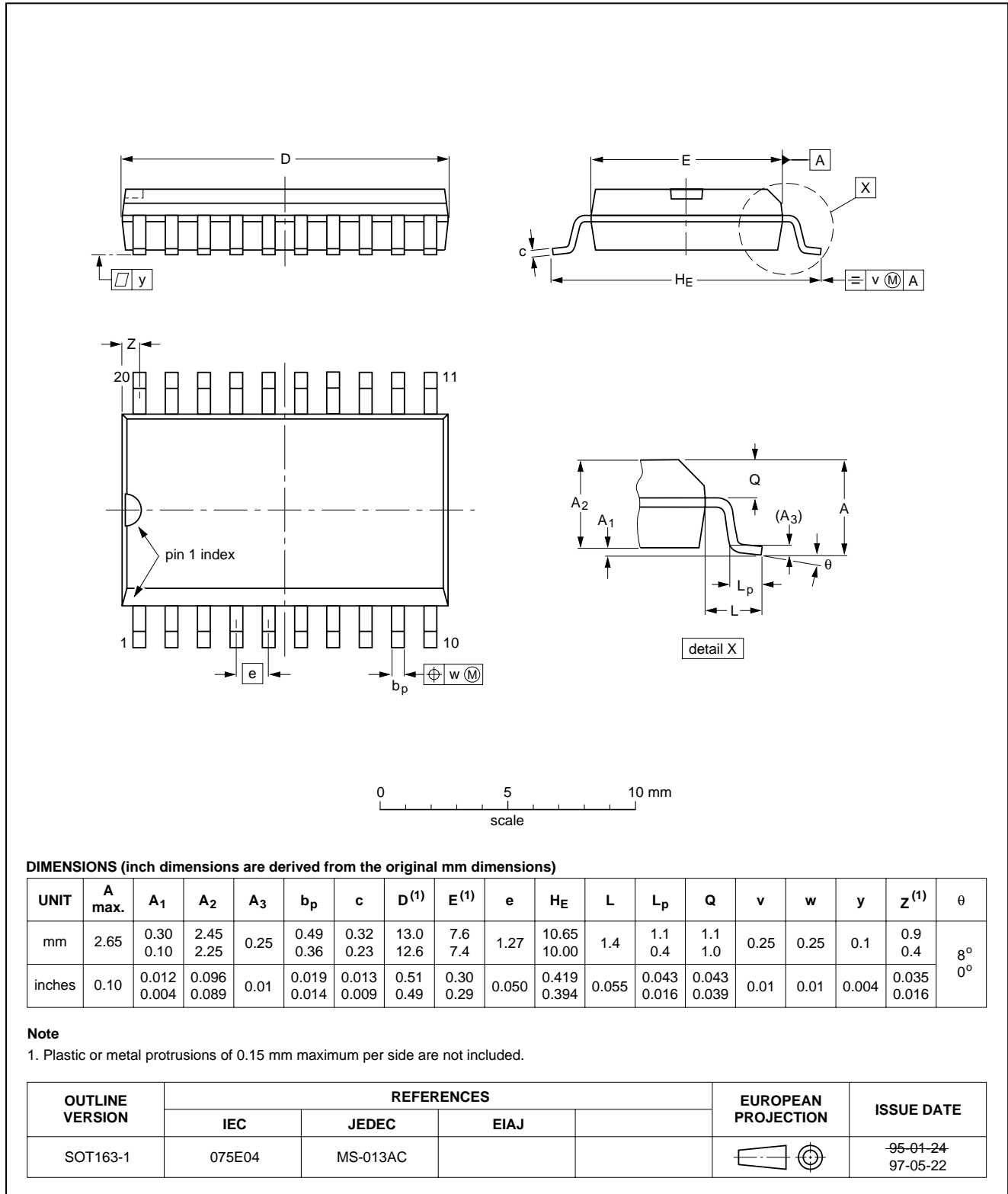1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|---|---|---|---|---|---|---|
| | IEC | JEDEC | EIAJ | | | |
| SOT146-1 | | | SC603 | | | 92-11-17 95-05-24 |

## Clock Generator Circuit for desktop video systems (CGC)　　SAA7197

**SO20: plastic small outline package; 20 leads; body width 7.5 mm**　　**SOT163-1**



pin 1 index

detail X

```
0          5          10 mm
|_____|_____|
          scale
```

**DIMENSIONS (inch dimensions are derived from the original mm dimensions)**

| UNIT | A max. | A₁ | A₂ | A₃ | b_p | c | D(1) | E(1) | e | H_E | L | L_p | Q | v | w | y | Z(1) | θ |
|------|--------|----|----|----|-----|---|------|------|---|-----|---|-----|---|---|---|---|------|---|
| mm | 2.65 | 0.30 0.10 | 2.45 2.25 | 0.25 | 0.49 0.36 | 0.32 0.23 | 13.0 12.6 | 7.6 7.4 | 1.27 | 10.65 10.00 | 1.4 | 1.1 0.4 | 1.1 1.0 | 0.25 | 0.25 | 0.1 | 0.9 0.4 | 8° 0° |
| inches | 0.10 | 0.012 0.004 | 0.096 0.089 | 0.01 | 0.019 0.014 | 0.013 0.009 | 0.51 0.49 | 0.30 0.29 | 0.050 | 0.419 0.394 | 0.055 | 0.043 0.016 | 0.043 0.039 | 0.01 | 0.01 | 0.004 | 0.035 0.016 | |

**Note**

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|--------|------|---|---------------------|------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT163-1 | 075E04 | MS-013AC | | | | 95-01-24 97-05-22 |

## Clock Generator Circuit for desktop video systems (CGC)

**SOLDERING**

**Introduction**

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *"IC Package Databook"* (order code 9398 652 90011).

**DIP**

SOLDERING BY DIPPING OR BY WAVE

The maximum permissible temperature of the solder is 260 °C; solder at this temperature must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified maximum storage temperature ($T_{stg\ max}$). If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

REPAIRING SOLDERED JOINTS

Apply a low voltage soldering iron (less than 24 V) to the lead(s) of the package, below the seating plane or not more than 2 mm above it. If the temperature of the soldering iron bit is less than 300 °C it may remain in contact for up to 10 seconds. If the bit temperature is between 300 and 400 °C, contact may be up to 5 seconds.

**SO**

REFLOW SOLDERING

Reflow soldering techniques are suitable for all SO packages.

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement.

Several techniques exist for reflowing; for example, thermal conduction by heated belt. Dwell times vary between 50 and 300 seconds depending on heating method. Typical reflow temperatures range from 215 to 250 °C.

Preheating is necessary to dry the paste and evaporate the binding agent. Preheating duration: 45 minutes at 45 °C.

WAVE SOLDERING

Wave soldering techniques can be used for all SO packages if the following conditions are observed:

- A double-wave (a turbulent wave with high upward pressure followed by a smooth laminar wave) soldering technique should be used.
- The longitudinal axis of the package footprint must be parallel to the solder flow.
- The package footprint must incorporate solder thieves at the downstream end.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Maximum permissible solder temperature is 260 °C, and maximum duration of package immersion in solder is 10 seconds, if cooled to less than 150 °C within 6 seconds. Typical dwell time is 4 seconds at 250 °C.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

REPAIRING SOLDERED JOINTS

Fix the component by first soldering two diagonally-opposite end leads. Use only a low voltage soldering iron (less than 24 V) applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C. When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 °C.

## DEFINITIONS

| Data sheet status | |
|---|---|
| Objective specification | This data sheet contains target or goal specifications for product development. |
| Preliminary specification | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification | This data sheet contains final product specifications. |
| **Limiting values** | |
| Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability. | |
| **Application information** | |
| Where application information is given, it is advisory and does not form part of the specification. | |

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**NOTES**

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